

PATENT

Serial No. 10/577,758

Amendment in Reply to Final Office Action of January 12, 2009
and Advisory Action of March 24, 2009

IN THE SPECIFICATION

Please amend the specification as follows:

Replace the paragraph on page 9, between lines 1-2 of the specification with the following:

A second ~~substrate 7~~ substrate 1, made of PC having a thickness of 0.6 mm is present adjacent the third auxiliary layer 6.